#### TOSHIBA Bi-CMOS Digital Integrated Circuit Silicon Monolithic

# TD74BC574P,TD74BC574F

Octal D-Type Flip-Flop with 3-State Outputs (Non-Inverted)

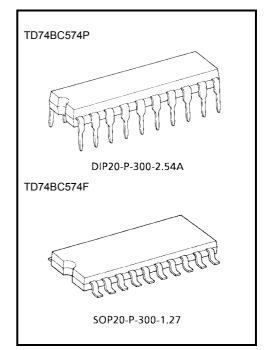
The TD74BC574P/TD74BC574F is a high-speed 8-bit flip-flop fabricated with silicon gate Bi-CMOS technology. It achieves the high-speed operation equivalent to the FAST family while maintaining the Bi-CMOS low-power dissipation. The TD74BC574P/F is a non-inverting flip-flop. Each bit is individually controlled by a clock input (CK) and an output enable input ( $\overline{OE}$ ). When the  $\overline{OE}$  input is high, all eight outputs are in the high-impedance state, which facilitates the interface with bus lines.

All inputs are equipped with resistors and diodes to protect against Electrostatic Discharge (ESD).

#### Features

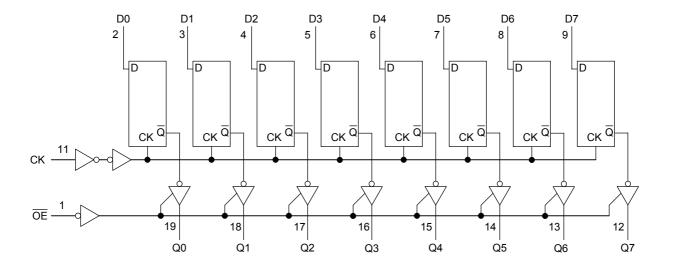
- High-speed operation .....t<sub>pd</sub> = 8.8 ns (typ.)
- Symmetrical output impedance ...... IOH = −3 mA (max)
- $I_{OL} = 24 \text{ mA} \text{ (max)}$
- Low power dissipation .....ICCD = 7 mA (typ.)
- $I_{CCZ} = 10 \ \mu A \ (typ.)$

- Pin and function compatible with FAST (74F574)



## Logic Diagram

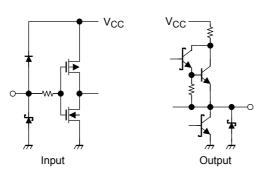
Weight DIP20-P-300-2.54A : 1.48 g (typ.) SOP20-P-300-1.27 : 0.25 g (typ.)



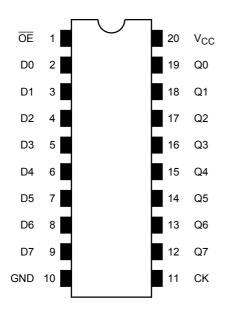


# <u>TOSHIBA</u>

# Input Protection Circuit and Output Equivalent Circuit



## Pin Assignment (top view)



# **Truth Table**

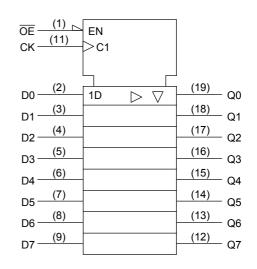
	Outputs		
ŌĒ	СК	D	Q
Н	Х	Х	Z
L		Х	Qn
L		L	L
L		Н	н

X: Don't care

Z: High impedance

Qn: No change

# Logic Symbol



# **Absolute Maximum Ratings**

Characteristi	cs	Symbol	Rating	Unit
Power supply voltage		V <sub>CC</sub>	–0.5 to 7.0	V
Input voltage		V <sub>IN</sub>	-1.2 to V <sub>CC</sub> + 0.5	V
Output voltage		VO	-0.5 to V <sub>CC</sub> + 0.5	V
Input clamp diode current		I <sub>IK</sub>	±30	mA
Output clamp diode curre	Output clamp diode current		-30	mA
Output current (output low state)		I <sub>OL</sub>	48	mA
Power dissipation	BC574P	PD	1380 (Note 1)	mW
Power dissipation	BC574F	۳D	860 (Note 1)	IIIVV
Storage temperature		T <sub>stg</sub>	–65 to 150	°C

Note 1:  $Ta = 25^{\circ}C$ 

# **Recommended Operating Conditions**

Characteristics		Symbol	Min	Тур.	Max	Unit	
Power supply voltage	V <sub>CC</sub>	4.5	5.0	5.5	V		
Input voltage	V <sub>IN</sub>	0	_	V <sub>CC</sub>	V		
Output voltage		V <sub>O</sub>	0	_	V <sub>CC</sub>	V	
Output current	High level	I <sub>OH</sub>	_	_	-3	mA	
Output current	Low level	I <sub>OL</sub>	_	_	24	ШA	
Operating temperature		T <sub>opr</sub>	-40	25	85	°C	

## **Electrical Characteristics**

#### DC Characteristics (unless otherwise specified, $V_{CC} = 4.5$ V to 5.5 V, Ta = -40°C to 85°C)

Characteristics		Symbol	Test Condition	V <sub>CC</sub>	Min	Typ. (Note 1)	Max	Unit
	High level	VIH	—		2.0	—	_	V
Input voltage	Low level	VIL	_		_	—	0.8	v
Input clamp voltage		VIK	I <sub>IK</sub> = -18 mA	4.5		_	-1.2	V
	High level	Maria	$\begin{array}{c c} & & & & & & & & $	4.5	2.4	3.4	_	
Output voltage	nigit level	V <sub>OH</sub>	I <sub>OH</sub> = -3.0 mA	4.75	2.7	3.4	_	V
	Low level	V <sub>OL</sub>	I <sub>OL</sub> = 24 mA	4.5			0.5	
		lj	$V_{IN} = V_{CC}$	5.5		_	±1.0	
Input current (all input	pins)	IIH	V <sub>IN</sub> = 2.7 V	5.5		_	±1.0	μA
	F leakage current	IIL	V <sub>IN</sub> = 0.5 V or GND	5.5			±1.0	
3-state OFF leakage current		I <sub>OZH</sub>	V <sub>O</sub> = 2.7 V	5.5 —			50	μA
		I <sub>OZL</sub>	$V_{O} = 0.5 V$	5.5		_	-50	μ <del>Λ</del>
Output short current (Note 2)		I <sub>OS</sub>	V <sub>O</sub> = GND	5.5	-60	_	-180	mA
		ICCL		5.5	_	20	27	mA
Quiescent supply curre	ent (total)	Іссн		5.5	_	10	50	
		I <sub>CCZ</sub>	All outputs are in the	5.5		10	50	μA
Quiescent supply current (each bit)		$\Delta I_{CC1}$	,	_	_		1.5	mA
		$\Delta I_{CC2}$	One input: $V_{IN} = V_{CC} - 2.1 V$ Other inputs: $V_{CC}$ or GND	_	_		1.5	IIIA

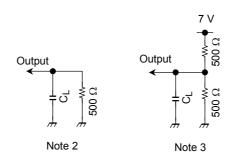
Note 1: Typical value is measured at V<sub>CC</sub> = 5.0 V and Ta =  $25^{\circ}$ C.

Note 2: Only one output at a time should be shorted. Duration should not exceed one second.

AC Characteristics (Input  $t_r = t_f = 2.5$  ns)

Characteristics		Symbol Test Condition	Ta = 25°C V <sub>CC</sub> = 5.0 V			$\begin{array}{l} Ta=-40^{\circ}\\ V_{CC}=5.0 \end{array}$	Unit		
		0,		Min	Тур.	Max	Min	Max	•
Propagation delay time	CK-Q	t <sub>pLH</sub>		3.0	8.8	11.5	3.0	13.0	ns
Tropagation delay time	OIV-Q	t <sub>pHL</sub>		3.0	8.8	11.0	3.0	13.0	
3-state output enable time	OE -Q	t <sub>pZH</sub>	- C <sub>L</sub> = 50 pF	3.0	10.4	12.5	3.0	14.5	ns
5-State Output enable time		t <sub>pZL</sub>		3.0	8.2	9.5	3.0	13.5	
3-state output disable time	OE -Q	t <sub>pHZ</sub>		3.0	6.5	9.5	3.0	11.5	ns
	OL-Q	t <sub>pLZ</sub>		3.0	5.8	8.5	3.0	10.0	115
Maximum clock frequency		f <sub>MAX</sub>		100	_	_	70	_	MHz
Dynamic supply current		ICCD	f = 1 MHz Output open		7	12		15	mA

Note 1: When measuring  $t_{pLH}$ ,  $t_{pHL}$ ,  $t_{pZH}$  and  $t_{pHZ}$ , the output pin should be connected as shown in Note 2. When measuring  $t_{pZL}$ , and  $t_{pLZ}$ , the output pin should be connected as shown in Note 3.



AC Characteristics (Input  $t_r = t_f = 2.5 \text{ ns}$ )

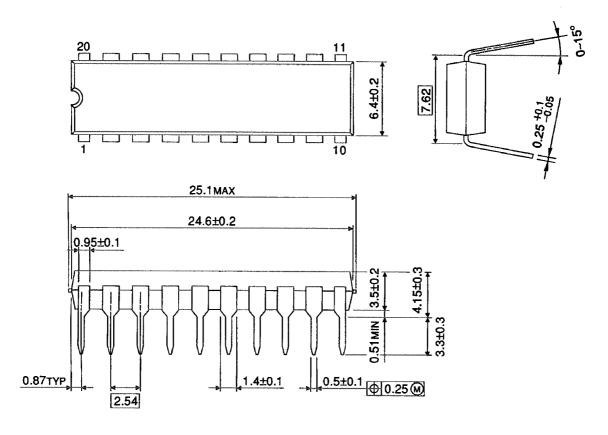
Characteristics		Symbol Test Condition	Ta = 25°C V <sub>ÇC</sub> = 5.0 V			Ta = -40° V <sub>CC</sub> = 5.0			
		Cymbol	rest condition	Min	Тур.	Max	Min	Max	Onic
Pulse width	СК	t <sub>w (L)</sub>		6			6	_	ns
	CR	t <sub>w (H)</sub>		7	—	_	7	—	115
Setup time	D-CK	t <sub>s (L)</sub>	$C_L = 50 \text{ pF}$	2			2		ns
		t <sub>s (H)</sub>	$R_L = 500 \ \Omega$	2	—	_	2	—	115
Hold time	D-CK	t <sub>h (L)</sub>	]	2	_		2		ns
	D-CK	D-CK t <sub>h (H)</sub>		2	—	—	2	_	115

# **TOSHIBA**

# Package Dimensions

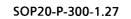
DIP20-P-300-2.54A

Unit : mm

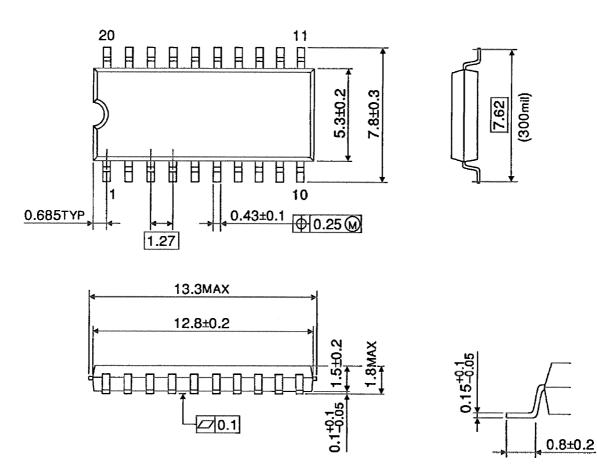


Weight: 1.48 g (typ.)

#### **Package Dimensions**



Unit : mm



Weight: 0.25 g (typ.)

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